

High voltage ultrafast rectifier

Datasheet - production data

Features

- Low forward voltage drop
- High reliability
- High surge current capability
- Soft switching for reduced EMI disturbances
- Planar technology

Description

The STTH310, which uses ST ultrafast high voltage planar technology, is specially suited for free-wheeling, clamping, snubbering, demagnetization in power supplies and other power switching applications.

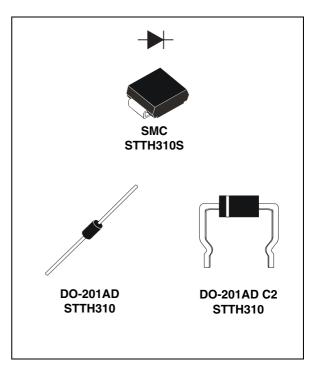


Table 1. Device summary

Symbol	Value
I _{F(AV)}	3 A
V _{RRM}	1000 V
T _{j(max)}	+175 °C
V _F (max)	1.42 V
t _{rr} (max)	75 ns

Characteristics STTH310

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parame	Value	Unit		
V_{RRM}	Repetitive peak reverse voltage	1000	V		
1	Average forward current & = 0.5	T _L = 75 °C, δ = 0.5	DO-201AD	3	Α
$I_{F(AV)}$ Average forward current, $\delta = 0.5$	T _L = 75 °C, δ = 0.5	SMC	3	A	
	Forward ourge ourrent	$t_{\rm n} = 8.3 \text{ ms sinusoidal} \cdot$	DO-201AD	55	۸
IFSM	FSM Forward surge current $t_p = 8.3 \text{ ms sin}$		SMC	45	Α
T _{stg}	Storage temperature range				°C
T _j	Operating junction temperature range			-40 to +175	°C

Table 3. Thermal parameters

Symbol	Parameter			Value	Unit
В	Junction to lead	L = 10 mm	DO-201AD	20	
R _{th(j-l)} Junction to lead	Junction to lead		SMC	20	°C/W
R _{th(j-a)}	Junction to ambient	L = 10 mm	DO-201AD	75	

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
1_	Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-	-	10	μΑ
I _R Reverse leakage current	T _j = 125 °C	VR — VRRM	-	-	50	μΛ	
V _F Forward voltage drop		T _j = 25 °C	I _F = 3 A	-	-	1.7	V
V _F Forward voltage drop	T _j = 150 °C	IF = 3 A	-	0.98	1.42	V	

To evaluate the conduction losses use the following equation: P = 1.20 x $I_{F(AV)}$ + 0.075 $I_{F}^{2}_{(RMS)}$

 Table 5.
 Dynamic electrical characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{rr}	Reverse recovery time	$I_F = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}$ $I_R = 1 \text{ A}, T_j = 25 ^{\circ}\text{C}$	-	-	75	ns
t _{fr}	Forward recovery time	$I_F = 3 \text{ A}, dI_F/dt = 50 \text{ A/}\mu\text{s}$	ı	-	300	ns
V _{FP}	Forward recovery voltage	$V_{FR} = 1.1 \text{ x } V_{Fmax}, T_j = 25 ^{\circ}\text{C}$	-	-	12	V

STTH310 Characteristics

Figure 1. Conduction losses versus average current

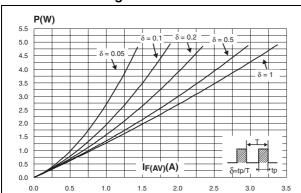


Figure 2. Forward voltage drop versus forward current

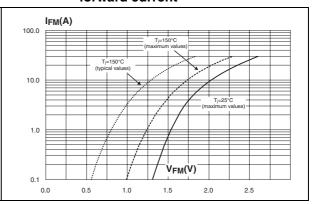


Figure 3. Relative variation of thermal impedance junction ambient versus pulse duration (DO-201AD)

Zth(j-c)/Rth(j-c)

1.0

0.9

Epoxy printed circuit board, FR4,

0.7

0.6

0.5

0.4

0.3

0.2

0.1

0.0

1.E-01

1.E+00

1.E+01

1.E+02

1.E+03

Figure 4. Relative variation of thermal impedance junction ambient versus pulse duration (SMC)

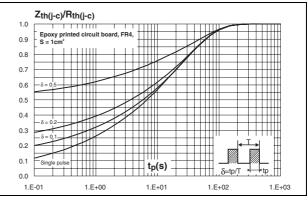
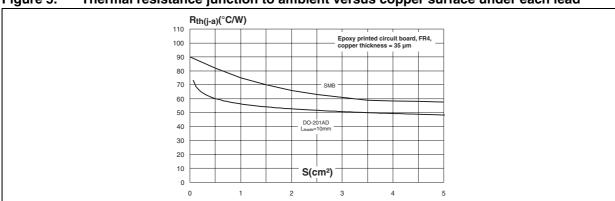


Figure 5. Thermal resistance junction to ambient versus copper surface under each lead



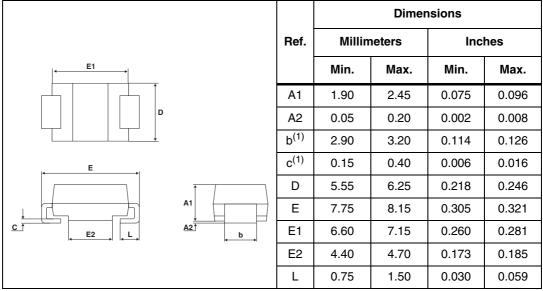
Package information STTH310

2 Package information

- Epoxy meets UL94, V0
- Band indicates cathode
- Cooling method: by conduction (C)

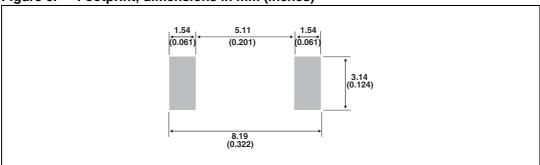
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Table 6. SMC dimensions



^{1.} Dimensions b and c apply to plated leads

Figure 6. Footprint, dimensions in mm (inches)



STTH310 Package information

Table 7. DO-201AD dimensions

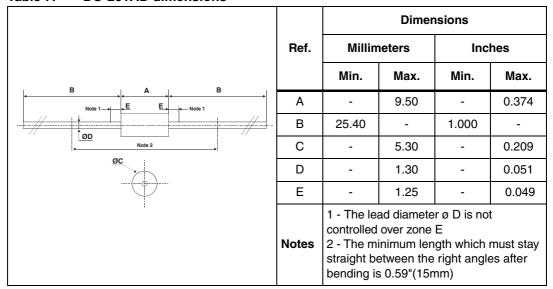
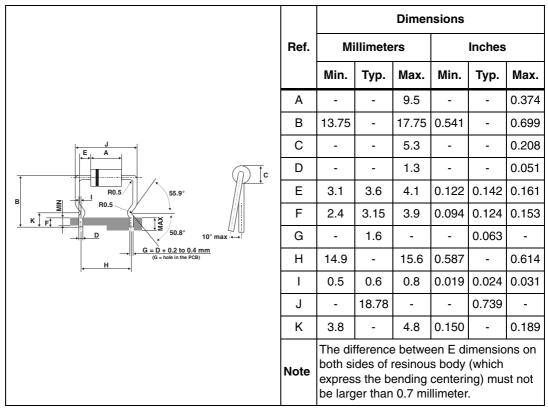


Table 8. DO-201AD C2 dimensions



Ordering information STTH310

3 Ordering information

Table 9. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH310S	S10	SMC	0.245 g	2500	Tape and reel
STTH310	STTH310	DO-201AD	1.16 g	600	Ammopack
STTH310RL	STTH310	DO-201AD	1.16 g	1900	Tape and reel
STTH310-C2	STTH 310	DO-201AD C2	1.12 g	500	Box

4 Revision history

Table 10. Document revision history

Date	Revision	Changes
Jan-2003	1	First release.
03-Apr-2007	2	DO-201AD C2 package added. SMC package information updated.
07-Dec-09	3	Updated <i>Table 6</i> package dimensions.
21-Jun-2012	4	Updated T_j in <i>Table 1</i> and <i>Table 2</i> and change min. T_{stg} to -65 °C in <i>Table 2</i> .

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